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(54) Title: CURABLE EPOXY COMPOSITIONS, METHODS AND ARTICLES MADE THEREFROM

(57) Abstract: A curable epoxy formulation is provided in the present invention. The formulation comprises an epoxy monomer, an organofunctionalized colloidal silica, cure catalyst, and optional reagents. Further embodiments of the present invention include a method for making the epoxy formulation and a semiconductor package comprising the curable epoxy formulation.

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